

## 150V N-Channel MOSFET

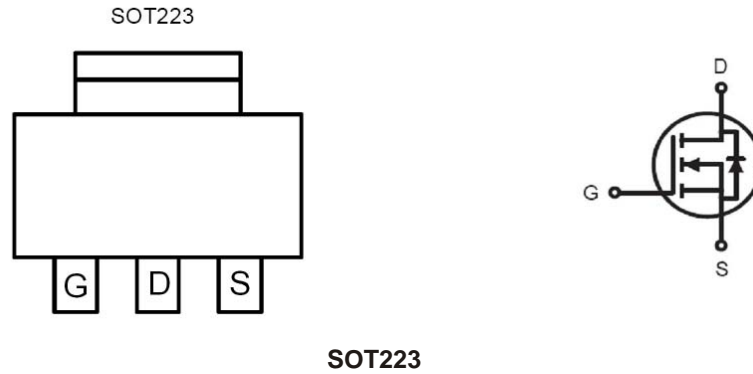
- Features**

150V/2.8A ,  
 $R_{DS(ON)} < 300m\Omega @ V_{GS} = 10V$   
 Lead Free Available (RoHS Compliant)

- General Description**

The FS2244 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . this device is well suited for high current load applications.

- Pin Configuration**



- Absolute Maximum Ratings**  $T_A = 25^\circ C$  unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	150	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current ( $T_J = 150^\circ C$ ) <sup>a</sup>	$I_D$	$T_A = 25^\circ C$	A
		$T_A = 70^\circ C$	
Pulsed Drain Current <sup>b</sup>	$I_{DM}$	12	
Avalanche Current <sup>b</sup>	$I_{AS}$	15	
Avalanche energy	$E_{AS}$	15	mJ
Power Dissipation <sup>a</sup>	$P_D$	$T_A = 25^\circ C$	W
		$T_A = 70^\circ C$	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ C$

Notes

- a. Surface Mounted on 1x1FR4 Board.
- b. Pulse width limited maximum junction temperature

## ● Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

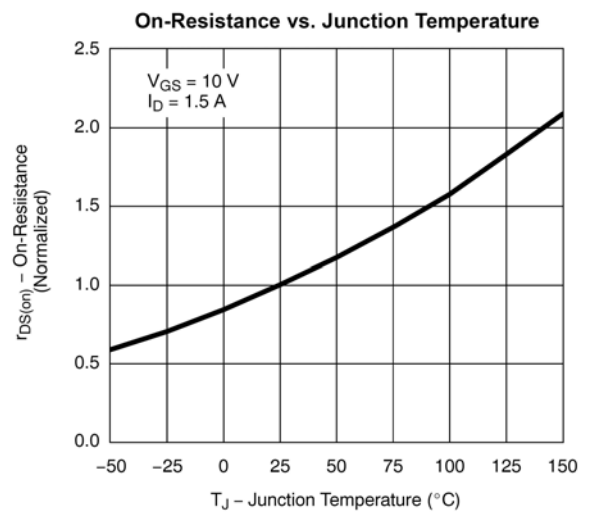
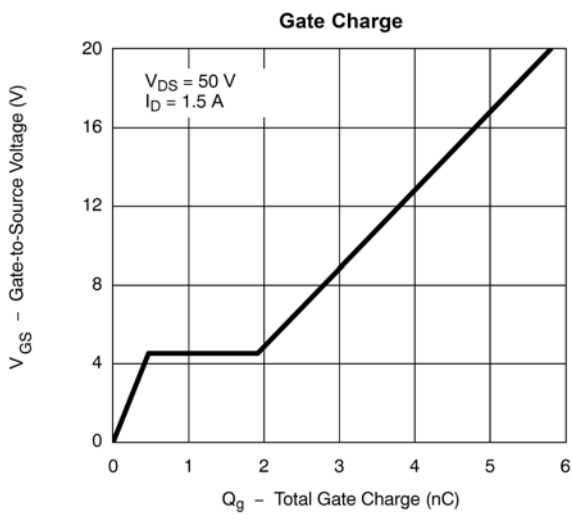
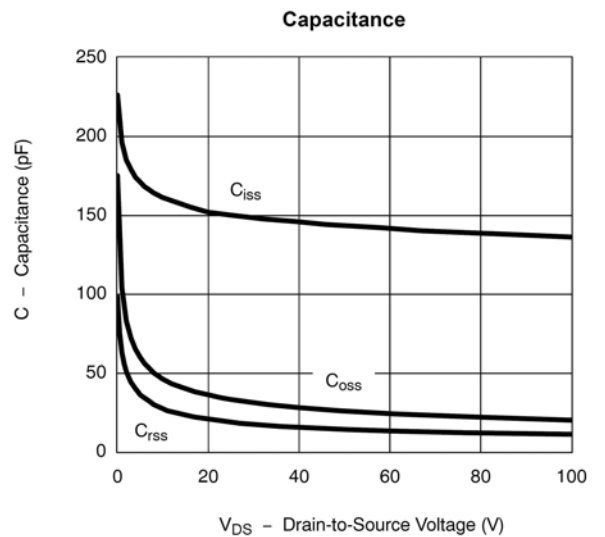
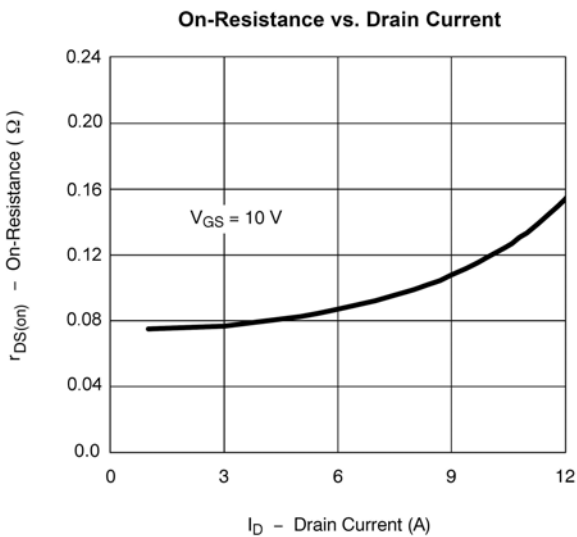
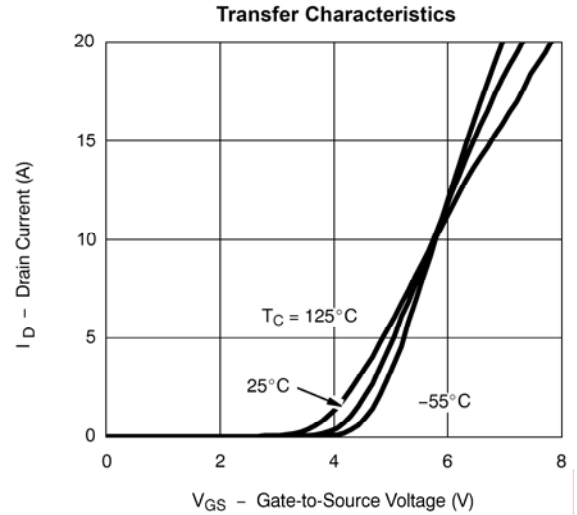
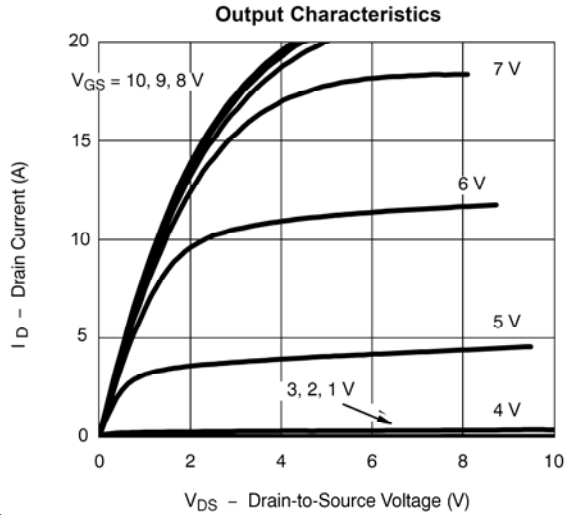
Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V	150			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0			1	μA
		T <sub>A</sub> =25°C				
		T <sub>A</sub> =70°C			60	
I <sub>GSS</sub>	Gate-Body leakage current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±0.1	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> I <sub>D</sub> =250μA	2		4	V
I <sub>D(ON)</sub>	On state drain current <sup>a</sup>	V <sub>GS</sub> =10V, V <sub>DS</sub> ≥15V	10.8			A
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>a</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A		260	300	mΩ
		V <sub>GS</sub> =6V, I <sub>D</sub> =10A			320	
g <sub>FS</sub>	Forward Trans conductance <sup>a</sup>	V <sub>DS</sub> =15V, I <sub>D</sub> =10A		6.5		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =10A, V <sub>GS</sub> =0V	0.3		1.2	V
I <sub>S</sub>	Maximum Body-Diode Continuous Current				1.2	A
<b>Dynamic<sup>b</sup></b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =3A		3.2		nC
Q <sub>gs</sub>	Gate - Source Charge			0.45		
Q <sub>gd</sub>	Gate - Drain Charge			1.6		
R <sub>g</sub>	Gate resistance		0.5		2.5	Ω
<b>Switching</b>						
t <sub>D(on)</sub>	Turn-On Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, R <sub>L</sub> =30Ω, R <sub>GEN</sub> =6Ω, I <sub>D</sub> =0.5A		7	12	ns
t <sub>r</sub>	Turn-On Rise Time			9.5	17	
t <sub>D(off)</sub>	Turn-Off Delay Time			8	15	
t <sub>f</sub>	Turn-Off Fall Time			10	15	
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =3A, dI/dt=100A/μs		40	90	

### Notes

a. Pulse test: PW≤300 us duty cycle ≤2%

b. Guaranteed by design, not subject to production testing.

● **TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**



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